











LM158, LM158A, LM258, LM258A LM358, LM358A, LM358B, LM358BA, LM2904, LM2904B, LM2904BA, LM2904V

SLOS068W -JUNE 1976-REVISED OCTOBER 2019

## **Industry-Standard Dual Operational Amplifiers**

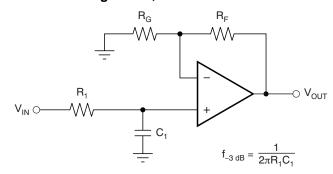
#### 1 Features

- Wide supply range of 3 V to 36 V (B version)
- Quiescent current: 300 μA per amplifier (B version, typical)
- Unity-gain bandwidth of 1.2 MHz (B version)
- Common-mode input voltage range includes ground, enabling direct sensing near ground
- Low input offset voltage of 3 mV at 25°C (A and B versions, maximum)
- Internal RF and EMI filter (B version)
- On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

## 2 Applications

- Merchant network and server power supply units
- Multi-function printers
- · Power supplies and mobile chargers
- Motor control: AC induction, brushed DC, brushless DC, high-voltage, low-voltage, permanent magnet, and stepper motor
- Desktop PC and motherboard
- · Indoor and outdoor air conditioners
- · Washers, dryers, and refrigerators
- AC inverters, string inverters, central inverters, and voltage frequency drives
- Uninterruptible power supplies
- Programmable logic controllers
- · Electronic point-of-sale systems

#### Single-Pole, Low-Pass Filter



# $\frac{V_{OUT}}{V_{IN}} = \left(1 + \frac{R_F}{R_G}\right) \left(\frac{1}{1 + sR_1C_1}\right)$

## 3 Description

The LM358B and LM2904B devices are the nextgeneration versions of the industry-standard operational amplifiers (op amps) LM358 and LM2904, which include two high-voltage (36-V) op amps. These devices provide outstanding value for costsensitive applications, with features including low offset (300 µV, typical), common-mode input range to ground, and high differential input voltage capability.

The LM358B and LM2904B op amps simplify circuit design with enhanced features such as unity-gain stability, lower offset voltage of 3 mV (maximum at room temperature), and lower quiescent current of 300 µA per amplifier (typical). High ESD (2 kV, HBM) and integrated EMI and RF filters enable the LM358B and LM2904B devices to be used in the most rugged, environmentally challenging applications.

The LM358B and LM2904B amplifiers are available in industry standard packages, including SOIC, TSSOP, and VSSOP.

## Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)					
LM358B, LM2904B, LM358, LM358A, LM2904, LM2904V, LM258, LM258A	SOIC (8)	4.90 mm × 3.90 mm					
LM358B <sup>(2)</sup> , LM2904B <sup>(2)</sup> , LM358, LM358A, LM2904, LM2490V	TSSOP (8)	3.00 mm × 4.40 mm					
LM358B <sup>(2)</sup> , LM2904B <sup>(2)</sup> , LM358, LM358A, LM2904, LM2904V, LM258, LM258A	VSSOP (8)	3.00 mm × 3.00 mm					
LM358, LM2904	SO (8)	5.20 mm × 5.30 mm					
LM358, LM2904, LM358A, LM258, LM258A	PDIP (8)	9.81 mm × 6.35 mm					
LM158, LM158A	CDIP (8)	9.60 mm × 6.67 mm					
LM158, LM158A	LCCC (20)	8.89 mm × 8.89 mm					

- For all available packages, see the orderable addendum at the end of the data sheet.
- (2) Package is for preview only.

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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision V (September 2018) to Revision W

•	Added specification in the Device Comparison Table	4
•	Changed CDM ESD rating for LM358B and LM2904B in ESD Ratings	6
•	Changed V <sub>S</sub> to V+ in Recommended Operating Conditions	<b>7</b>
•	Changed Thermal Information for the LM158FK and LM158JG devices	<b>7</b>
•	Added Typical Characteristics section for the LM358B and LM2490B op amps	14
•	Added test circuit for THD+N and small-signal step response, G = -1 in the <i>Parameter Measurement Information</i> section	
•	Changed the Functional Block Diagram	24
•	Deleted preview designator from LM358B and LM2904B in the Related Links section	29
CI	changes from Revision U (January 2017) to Revision V	Page
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•	Changed the data sheet title	1
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•	Changed the data sheet title  Changed first four items in the <i>Features</i> section  Changed the first item in the Applications section and added four new items  Changed voltage values in the first paragraph of the <i>Description</i> section	1 1 1 1
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•	Changed the data sheet title  Changed first four items in the Features section  Changed the first item in the Applications section and added four new items  Changed voltage values in the first paragraph of the Description section  Changed text in the second paragraph of the Description section  Added devices LM358B and LM2904B to data sheet  Changed the first three rows of the Device Information table and added a a cross-referenced note for PREVIEW-	1 1 1 1 1
•	Changed the data sheet title  Changed first four items in the Features section  Changed the first item in the Applications section and added four new items  Changed voltage values in the first paragraph of the Description section  Changed text in the second paragraph of the Description section  Added devices LM358B and LM2904B to data sheet  Changed the first three rows of the Device Information table and added a a cross-referenced note for PREVIEW-status devices	1 1 1 1



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•	Changed all entries in the Absolute Maximum Ratings table except T <sub>J</sub> and T <sub>stg</sub>	6
•	Deleted lead temperature and case temperature from Absolute Maximum Ratings	6
•	Changed device listings and their voltage values in the ESD Ratings table	6
•	Changed "free-air temperature" to "ambient temperature" in the <i>Recommended Operating Conditions</i> condition statement	7
•	Changed table entries for all parameters in the Recommended Operating Conditions table	<mark>7</mark>
•	Added rows to the Thermal Information table, and a table note regarding device-package combinations	<mark>7</mark>
•	Deleted the Operating Conditions table	13
•	Added a condition statement to the <i>Typical Characteristics</i> section	21
•	Changed specific voltages to a Recommended Operating Conditions reference	
•	Changed unity-gain bandwidth from 0.7 MHz for all devices to 1.2 MHz for B-version devices	
•	Changed slew rate from.3 V/µs for all devices to 0.5 V/µs for B-version devices	
•	Changed the Input Common Mode Range section in multiple places throughout	
•	Changed V <sub>CC</sub> to V <sub>S</sub> in the <i>Application Information</i> section	
•	Subscripted the suffixes fro R <sub>I</sub> and R <sub>F</sub>	
	Changed Operational Amplifier Board Layout for Noninverting Configuration with an image that includes a dual op a	
		•
•	Added Preview designation to the LM358B and LM2904B devices in Table 1	29
· Ch	anges from Revision T (April 2015) to Revision U	Page
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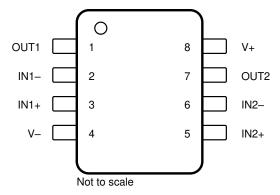
## 5 Device Comparison Table

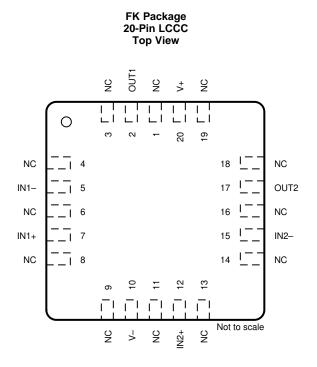
PART NUMBER	SUPPLY VOLTAGE	TEMPERATURE RANGE	V <sub>OS</sub> (MAXIMUM AT 25°C)	I <sub>Q</sub> / CH (TYPICAL AT 25°C)	INTEGRATED EMI FILTER	PACKAGE
LM358B	3 V–36 V	-40°C to 85°C	3 mV	300 μΑ	Yes	D, DGK, PW
LM2904B	3 V–36 V	-40°C to 125°C	3 mV	300 μΑ	Yes	D, DGK, PW
LM358	3 V–32 V	0°C to 70°C	7 mV	350 µA	No	D, PW, DGK, P, PS
LM2904	3 V–26 V	-40°C to 125°C	7 mV	350 μΑ	No	D, PW, DGK, P, PS
LM358A	3 V–32 V	0°C to 70°C	3 mV	350 µA	No	D, PW, DGK, P
LM2904V	3 V–32 V	-40°C to 125°C	7 mV	350 μΑ	No	D, PW
LM158	3 V–32 V	–55°C to 125°C	5 mV	350 µA	No	JG, FK
LM158A	3 V–32 V	–55°C to 125°C	3 mV	350 μΑ	No	JG, FK
LM258	3 V–32 V	-25°C to 85°C	5 mV	350 μΑ	No	D, DGK, P
LM258A	3 V–32 V	-25°C to 85°C	3 mV	350 µA	No	D, DGK, P



## 6 Pin Configuration and Functions

D, DGK, P, PS, PW, and JG Packages 8-Pin SOIC, VSSOP, PDIP, SO, TSSOP, and CDIP Top View





NC - No internal connection

#### **Pin Functions**

		PIN	I/O	DESCRIPTION						
NAME	LCCC <sup>(1)</sup>	SOIC, SSOP, CDIP, PDIP, SO, TSSOP, CFP <sup>(1)</sup>								
IN1-	5	2	1	Negative input						
IN1+	7	3	1	Positive input						
IN2-	15	6	1	Negative input						
IN2+	12	5	1	Positive input						
OUT1	2	1	0	Output						
OUT2	17	7	0	Output						
V-	10	4	_	Negative (lowest) supply or ground (for single-supply operation)						
NC	1, 3, 4, 6, 8, 9, 11, 13, 14, 16, 18, 19	_	_	No internal connection						
V+	20	8	_	Positive (highest) supply						

<sup>(1)</sup> For a listing of which devices are available in what packages, see Device Comparison Table.



## 7 Specifications

## 7.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT	
		LM358B, LM358BA, LM2904B, LM2904BA		±20 or 40		
Supply voltage, $V_S = ([V+] - [V-])$		LM158, LM258, LM358, LM158A, LM258A, LM358A, LM2904V	±16 or 3		V	
		LM2904		±13 or 26		
Differential input voltage, V <sub>ID</sub> <sup>(2)</sup>		LM358B, LM358BA, LM2904B, LM2904BA,LM158, LM258, LM358, LM158A, LM258A, LM358A, LM2904V	-32	32	V	
		LM2904	-26	26		
		LM358B, LM358BA, LM2904B, LM2904BA	-0.3	40		
Input voltage, V <sub>I</sub>	Either input	Either input	LM158, LM258, LM358, LM158A, LM258A, LM358A, LM2904V	-0.3	32	V
		LM2904	-0.3	26		
Duration of output short circuit (one amplif $V_S \le 15 \ V^{(3)}$	er) to ground at (or	r below) T <sub>A</sub> = 25°C,		Unlimited	s	
		LM158, LM158A	<b>–</b> 55	125		
		LM258, LM258A	-25	85		
Operating ambient temperature, T <sub>A</sub>		LM358B, LM358BA	-40	85	°C	
operating ambient temperature, 14	Operating ambient temperature, 14		0	70	J	
		LM2904B, LM2904BA, LM2904, LM2904V	-40	125		
Operating virtual-junction temperature, T <sub>J</sub>				150	°C	
Storage temperature, T <sub>stg</sub>			-65	150	°C	

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### 7.2 ESD Ratings

			VALUE	UNIT						
LM358E	LM358B, LM358BA, LM2904B, AND LM2904BA									
V Floatmatatic disablemen	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2000								
$V_{(ESD)}$	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±1000	V						
LM158,	LM158, LM258, LM358, LM158, LM258A, LM358A, LM2904, AND LM2904V									
V <sub>(ESD)</sub> Electrostatic discharge	Floatroatatia diaabaraa	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±500							
	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 (2)	±1000	V						

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

<sup>(2)</sup> Differential voltages are at IN+, with respect to IN-

<sup>3)</sup> Short circuits from outputs to V<sub>S</sub> can cause excessive heating and eventual destruction.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



## 7.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

			MIN	MAX	UNIT
Vs	Supply voltage, V <sub>S</sub> = ([V+] – [V–])	LM358B, LM358BA, LM2904B, LM2904BA	3	3 36	
		LM158, LM258, LM358, LM158A, LM258A, LM358A, LM2904V	3	30	V
		LM2904	3	26	
$V_{CM}$	Common-mode voltage		V-	V+ - 2	V
		LM358B, LM358BA	-40	85	
	Operating ambient temperature	LM2904B, LM2904BA, LM2904, LM2904V	-40	125	_
T <sub>A</sub>		LM358, LM358A	0	70	°C
		LM258, LM258A	-20	85	
		LM158, LM158A	-55	125	

## 7.4 Thermal Information

		LM258, LI	LM258, LM258A, LM358, LM358A, LM358B, LM358BA, LM2904, LM2904B, LM2904BA, LM2904V <sup>(2)</sup>				LM158,		
	THERMAL METRIC <sup>(1)</sup>		DGK (VSSOP)	P (PDIP)	PS (SO)	PW (TSSOP)	FK (LCCC)	JG (CDIP)	UNIT
		8 PINS	8 PINS	8 PINS	8 PINS	8 PINS	20 PINS	8 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	124.7	181.4	80.9	116.9	171.7	84.0	112.4	°C/W
$R_{\theta JC (top)}$	Junction-to-case (top) thermal resistance	66.9	69.4	70.4	62.5	68.8	56.9	63.6	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	67.9	102.9	57.4	68.6	99.2	57.5	100.3	°C/W
ΨЈТ	Junction-to-top characterization parameter	19.2	11.8	40	21.9	11.5	51.7	35.7	°C/W
ΨЈВ	Junction-to-board characterization parameter	67.2	101.2	56.9	67.6	97.9	57.1	93.3	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	_	_	_	_	_	10.6	22.3	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see Semiconductor and IC Package Thermal Metrics.

<sup>(2)</sup> For a listing of which devices are available in what packages, see Device Comparison Table.



## 7.5 Electrical Characteristics: LM358B and LM358BA

 $V_{S} = (V+) - (V-) = 5 \; V \; - \; 36 \; V \; (\pm 2.5 \; V \; - \; \pm 18 \; V), \; T_{A} = 25 ^{\circ}C, \; V_{CM} = V_{OUT} = V_{S}/2, \; R_{L} = 10 k \; connected \; to \; V_{S}/2, \; V_{CM} = V_{OUT} = V_{S}/2, \; V_{CM} = V_{OUT} = V_{S}/2, \; V_{CM} = V_{CM} =$ 

(unless otherwise noted)

	PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
OFFSET	VOLTAGE							
		LMOSOD				±0.3	±3.0	mV
\/	Input offect voltage	LM358B		$T_A = -40$ °C to +85°C			±4	mV
Vos	Input offset voltage	I MOEODA					±2.0	mV
		LM358BA		$T_A = -40$ °C to +85°C			±2.5	mV
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}^{(1)}$		±3.5	11	μV/°C
PSRR	Power Supply Rejection Ratio			1		±2	15	μV/V
	Channel separation, dc	f = 1 kHz to 20 kHz				±1		μV/V
INPUT V	OLTAGE RANGE	1						
		V <sub>S</sub> = 3 V to 36 V			(V-)		(V+) - 1.5	V
V <sub>CM</sub>	Common-mode voltage range	V <sub>S</sub> = 5 V to 36 V		$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	(V-)		(V+) - 2	V
		$(V-) \le V_{CM} \le (V+) - 1.5 \text{ V}$	/ V <sub>S</sub> = 3 V to 36 V			20	100	
CMRR	Common-mode rejection ratio	$(V-) \le V_{CM} \le (V+) - 2.0 \text{ V}$		T <sub>A</sub> = -40°C to +85°C		25	316	μV/V
INPUT B	IAS CURRENT	( , ) = . CM = ( ) =	13 111111	*A				
						±10	±35	nA
I <sub>B</sub>	Input bias current			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}^{(1)}$			±50	nA
				A 5 6.0 .00 0		0.5	4	nA
Ios	Input offset current			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}^{(1)}$		0.0	5	nA
dl <sub>OS</sub> /d <sub>T</sub>	Input offset current drift			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		10	J	pA/°C
NOISE	mpat onset candit unit			1A 40 0 10 103 0		10		pA C
	Input voltage noise	f = 0.1 to 10 Hz				3		u\/
E <sub>n</sub>	Input voltage noise Input voltage noise density	f = 1 kHz				40		μV <sub>PP</sub> nV/√/H
e <sub>n</sub>	MPEDANCE	I = I KIIZ				40		IIV/ V/FI
					Ι .	10 11 0 1		MOILs
Z <sub>ID</sub>	Differential					10    0.1		MΩ   p
Z <sub>IC</sub>	Common-mode					4    1.5		GΩ   p
OPEN-LO	OOP GAIN							
A <sub>OL</sub>	Open-loop voltage gain	V <sub>S</sub> = 15 V; V <sub>O</sub> = 1 V to 1	1 V; R <sub>L</sub> ≥ 10 kΩ, connected to (V-)		70	140		V/mV
				$T_A = -40$ °C to +85°C	35			V/mV
	NCY RESPONSE	T.			1			
GBW	Gain bandwidth product					1.2		MHz
SR	Slew rate	G = + 1				0.5		V/µs
$\Theta_{m}$	Phase margin	$G = + 1, R_L = 10k\Omega, C_L =$	20 pF			56		۰
t <sub>OR</sub>	Overload recovery time	V <sub>IN</sub> × gain > V <sub>S</sub>				10		μs
t <sub>s</sub>	Settling time		Step , G = +1, C <sub>L</sub> = 100 pF			4		μs
THD+N	Total harmonic distortion + noise	$G = + 1$ , $f = 1$ kHz, $V_0 = 3$	$3.53 \text{ V}_{\text{RMS}}, \text{ V}_{\text{S}} = 36 \text{V}, \text{ R}_{\text{L}} = 100 \text{k}, \text{ I}_{\text{OUT}} \le \pm 50 \mu$	A, BW = 80 kHz		0.001		%
OUTPUT		T						
				$I_{OUT} = 50 \mu A$		1.35	1.42	V
		Positive Rail (V+)		I <sub>OUT</sub> = 1 mA		1.4	1.48	V
Vo	Voltage output swing from rail			$I_{OUT} = 5 \text{ mA}^{(1)}$		1.5	1.61	V
VO	Voltage output swing from rain			$I_{OUT} = 50 \mu A$		100	150	mV
		Negative Rail (V-)		I <sub>OUT</sub> = 1 mA		0.75	1	V
			$V_S = 5 \text{ V}, \text{ RL} \le 10 \text{ k}\Omega \text{ connected to (V-)}$	$T_A = -40$ °C to +85°C		5	20	mV
		V <sub>S</sub> = 15 V; V <sub>O</sub> = V-;	Source <sup>(1)</sup>		-20	-30		
		V <sub>ID</sub> = 1 V	Source	$T_A = -40$ °C to +85°C	-10			mA
Io	Output current	V <sub>S</sub> = 15 V; V <sub>O</sub> = V+;	Cink(1)		10	20	-	mA
		V <sub>ID</sub> = -1 V			5			
		V <sub>ID</sub> = -1 V; V <sub>O</sub> = (V-) + 20	00 mV		60	100		μА
I <sub>sc</sub>	Short-circuit current	V <sub>S</sub> = 20 V, (V+) = 10 V, (	V-) = -10 V, V <sub>O</sub> = 0 V			±40	±60	mA
C <sub>LOAD</sub>	Capacitive load drive					100		pF
	'	f = 1 MHz, I <sub>O</sub> = 0 A				300		Ω
	Open-loop output resistance							
R <sub>O</sub>		1			II		· · · · · · · · · · · · · · · · · · ·	
R <sub>o</sub>	SUPPLY  Quiescent current per amplifier	V <sub>S</sub> = 5 V; I <sub>O</sub> = 0 A				300	460	μA

(1) Specified by characterization only

Submit Documentation Feedback



## 7.6 Electrical Characteristics: LM2904B and LM2904B

 $V_{S} = (V+) - (V-) = 5 \; V \; - \; 36 \; V \; (\pm 2.5 \; V \; - \; \pm 18 \; V), \; T_{A} = 25 ^{\circ}C, \; V_{CM} = V_{OUT} = V_{S}/2, \; R_{L} = 10 k \; connected \; to \; V_{S}/2, \; V_{CM} = V_{OUT} = V_{S}/2, \; V_{CM} = V_{OUT} = V_{S}/2, \; V_{CM} = V_{CM} =$ 

	PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
OFFSET	VOLTAGE							
						±0.3	±3.0	mV
		LM2904B		T <sub>A</sub> = -40°C to +125°C			±4	mV
Vos	Input offset voltage			1 <sub>A</sub> = 10 0 to 1120 0			±2.0	mV
		LM2904BA		T <sub>A</sub> = -40°C to +125°C			±2.5	mV
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift			$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}^{(1)}$		±3.5	12	μV/°C
PSRR	Power Supply Rejection Ratio			1 <sub>A</sub> = 10 0 to 1120 0		±2	15	μV/V
	Channel separation, dc	f = 1 kHz to 20 kHz				±1		μV/V
INPUT V	OLTAGE RANGE	1 = 1 M IZ to Zo M IZ						P*/
		V <sub>S</sub> = 3 V to 36 V			(V-)		(V+) - 1.5	V
$V_{CM}$	Common-mode voltage range	V <sub>S</sub> = 5 V to 36 V		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	(V-)		(V+) - 2	V
		$(V-) \le V_{CM} \le (V+) - 1.5 \text{ V}$	V <sub>0</sub> = 3 V to 36 V	1 <sub>A</sub> = 40 0 to 1120 0	(* )	20	100	•
CMRR	Common-mode rejection ratio	$(V-) \le V_{CM} \le (V+) - 1.5 V$ $(V-) \le V_{CM} \le (V+) - 2.0 V$		T <sub>A</sub> = -40°C to +125°C		25	316	μV/V
INDI IT D	IAS CURRENT	(V-) = V <sub>CM</sub> = (V+) - 2.0 V	V <sub>S</sub> = 3 V to 30 V	1A = -40 C to +125 C		2.5	310	
INFOLD	IA3 CORRENT					±10	±35	nA
$I_B$	Input bias current			$T_A = -40$ °C to +125°C <sup>(1)</sup>		±10	±50	
				1 <sub>A</sub> = -40 C to +125 C		0.5	±30 4	nA
Ios	Input offset current			T 4000 to 140500(1)		0.5		nA
ali /al	Land offer a comment white			$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}^{(1)}$		40	5	nA
dl <sub>OS</sub> /d <sub>T</sub>	Input offset current drift			$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		10		pA/°C
NOISE	1							
En	Input voltage noise	f = 0.1 to 10 Hz				3		μV <sub>PP</sub>
e <sub>n</sub>	Input voltage noise density	f = 1 kHz				40		nV/√/Hz
	MPEDANCE							
Z <sub>ID</sub>	Differential				1	10    0.1		MΩ   pF
Z <sub>IC</sub>	Common-mode					4    1.5		GΩ   pF
OPEN-LO	OOP GAIN			T				
A <sub>OL</sub>	Open-loop voltage gain	V <sub>S</sub> = 15 V; V <sub>O</sub> = 1 V to 11	V; R <sub>L</sub> ≥ 10 kΩ, connected to (V-)		70	140		V/mV
				$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	35			V/mV
	NCY RESPONSE							
GBW	Gain bandwidth product					1.2		MHz
SR	Slew rate	G = + 1				0.5		V/µs
$\Theta_{m}$	Phase margin	$G = + 1$ , $R_L = 10k\Omega$ , $C_L = 2$	20 pF			56		٥
t <sub>OR</sub>	Overload recovery time	V <sub>IN</sub> × gain > V <sub>S</sub>				10		μs
t <sub>s</sub>	Settling time	To 0.1%, V <sub>S</sub> = 5 V, 2-V St	ep , G = +1, C <sub>L</sub> = 100 pF			4		μs
THD+N	Total harmonic distortion + noise	$G = + 1$ , $f = 1$ kHz, $V_0 = 3$	.53 $V_{RMS}$ , $V_{S} = 36V$ , $R_{L} = 100k$ , $I_{OUT} \le \pm 50\mu$	A, BW = 80 kHz		0.001		%
OUTPUT					1			
				I <sub>OUT</sub> = 50 μA		1.35	1.42	V
		Positive Rail (V+)		I <sub>OUT</sub> = 1 mA		1.4	1.48	V
Vo	Voltage output swing from rail			$I_{OUT} = 5 \text{ mA}^{(1)}$		1.5	1.61	V
<b>v</b> <sub>0</sub>	Voltage output swing from fair			I <sub>OUT</sub> = 50 μA		100	150	mV
		Negative Rail (V-)		I <sub>OUT</sub> = 1 mA		0.75	1	V
			$V_S = 5 \text{ V}, \text{ RL} \le 10 \text{ k}\Omega$ connected to (V-)	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$		5	20	mV
		V <sub>S</sub> = 15 V; V <sub>O</sub> = V-; V <sub>ID</sub> =	2 (1)		-20	-30		
		1 V	Source <sup>(1)</sup>	$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	-10			
Io	Output current	V <sub>S</sub> = 15 V; V <sub>O</sub> = V+; V <sub>ID</sub> = -1 V	(4)		10	20		mA
		= -1 V	Sink <sup>(1)</sup>	T <sub>A</sub> = -40°C to +125°C	5			
		V <sub>ID</sub> = -1 V; V <sub>O</sub> = (V-) + 200	) mV		60	100		μА
I <sub>sc</sub>	Short-circuit current	V <sub>S</sub> = 20 V, (V+) = 10 V, (V				±40	±60	mA
C <sub>LOAD</sub>	Capacitive load drive					100		pF
Ro	Open-loop output resistance	f = 1 MHz, I <sub>O</sub> = 0 A				300		Ω
POWER					I			
I <sub>Q</sub>	Quiescent current per amplifier	V <sub>S</sub> = 5 V; I <sub>O</sub> = 0 A				300	460	μA
	Quiescent current per amplifier	$V_S = 36 \text{ V}; I_O = 0 \text{ A}$		$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$			800	μA
lα	«alescent current per amplifier	v <sub>S</sub> - 30 v, i <sub>O</sub> = 0 A		1			800	μΑ

#### (1) Specified by characterization only



## 7.7 Electrical Characteristics: LM358, LM358A

For  $V_S = (V+) - (V-) = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ , (unless otherwise noted)

	PARAMETER		TEST COND	OITIONS(1)		MIN	TYP <sup>(2)</sup>	MAX	UNIT
OFFSET	VOLTAGE								
							3	7	
			21/1/	LM358	T <sub>A</sub> = 0°C to 70°C			9	
Vos	Input offset voltage	$V_S = 5 \text{ V to } 30 \text{ V}; V_{CM} = 0$	0 V; V <sub>O</sub> = 1.4	LMOFOA	1 <sub>A</sub> = 0 C to 70 C		2	3	mV
				LM358A	T 000 to 7000			5	
					T <sub>A</sub> = 0°C to 70°C			5	
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift			LM358	$T_A = 0$ °C to 70°C		7		μV/°C
				LM358A	$T_A = 0$ °C to 70°C		7	20	
PSRR	Input offset voltage vs power supply $(\Delta V_{IO}/\Delta V_{S})$	V <sub>S</sub> = 5 V to 30 V				65	100		dB
V <sub>01</sub> / V <sub>02</sub>	Channel separation	f = 1 kHz to 20 kHz					120		dB
	DLTAGE RANGE	1 = 1 M IE to 20 M IE					.20		
		V <sub>S</sub> = 5 V to 30 V		LM358					
		V <sub>S</sub> = 30 V		LM358A		(V-)		(V+) - 1.5	
V <sub>CM</sub>	Common-mode voltage range								V
		V <sub>S</sub> = 5 V to 30 V		LM358	T <sub>A</sub> = 0°C to 70°C	(V-)		(V+) - 2	
		V <sub>S</sub> = 30 V		LM358A					
CMRR	Common-mode rejection ratio	$V_S = 5 \text{ V to } 30 \text{ V; } V_{CM} = 0$	0 V			65	80		dB
INPUT BI	AS CURRENT							1	
				LM358			-20	-250	
I <sub>B</sub>	Input bias current	V <sub>O</sub> = 1.4 V			$T_A = 0$ °C to 70°C			-500	nA
-в	mput blue current	70		LM358A			-15	-100	
				LIVIOOOA	$T_A = 0$ °C to 70°C			-200	
				LMOED			2	50	
		V 44V		LM358	T <sub>A</sub> = 0°C to 70°C			150	
los	Input offset current	V <sub>O</sub> = 1.4 V					2	30	nA
				LM358A	T <sub>A</sub> = 0°C to 70°C			75	
					7		10		
dl <sub>OS</sub> /d <sub>T</sub>	Input offset current drift			LM358A	T <sub>A</sub> = 0°C to 70°C			300	pA/°C
NOISE					7				
e <sub>n</sub>	Input voltage noise density	f = 1 kHz					40		nV/√ <del>Hz</del>
OPEN-LO									
						25	100		
A <sub>OL</sub>	Open-loop voltage gain	$V_S = 15 \text{ V}; V_O = 1 \text{ V to } 1^{\circ}$	1 V; $R_L \ge 2 k\Omega$		T <sub>A</sub> = 0°C to 70°C	15			V/mV
FREQUE	NCY RESPONSE				· A				
GBW	Gain bandwidth product						0.7		MHz
SR	Slew rate	G = +1					0.3		V/µs
OUTPUT									
			V <sub>S</sub> = 30 V; R <sub>I</sub>	- 2 kO	T <sub>A</sub> = 0°C to 70°C			4	
		Positive rail	$V_S = 30 \text{ V}; R_L$		14 - 0 0 10 10 0		2	3	V
Vo	Voltage output swing from rail	r ositive rail							V
		N 0 3	V <sub>S</sub> = 5 V; R <sub>L</sub> 2		T 000 / 7000			1.5	.,,
		Negative rail	$V_S = 5 \text{ V}; R_L = 5 \text{ V}$	≤ 10 kΩ	$T_A = 0$ °C to 70°C		5	20	mV
		V <sub>S</sub> = 15 V; V <sub>O</sub> = 0 V; V <sub>ID</sub>				-20	-30		
		= 1 V	Source	LM358A				-60	
lo	Output current				$T_A = 0$ °C to 70°C	-10			mA
5	- Separation,	$V_S = 15 \text{ V}; V_O = 15 \text{ V}; V_D = -1 \text{ V}$ Sink				10	20		
		V <sub>ID</sub> = -1 V	Jiiik		$T_A = 0$ °C to 70°C	5			
		$V_{ID} = -1 \text{ V}; V_{O} = 200 \text{ mV}$				12	30		μΑ
I <sub>sc</sub>	Short-circuit current	V <sub>S</sub> = 10 V; V <sub>O</sub> = V <sub>S</sub> / 2					±40	±60	mA
POWER S	SUPPLY	1			<b>!</b>				
	Quiescent current per	V <sub>O</sub> = 2.5 V; I <sub>O</sub> = 0 A					350	600	
l <sub>Q</sub>	amplifier	V <sub>S</sub> = 30 V; V <sub>O</sub> = 15 V; I <sub>O</sub>	= 0 A		$T_A = 0^{\circ}C \text{ to } 70^{\circ}C$		500	1000	μΑ
	•	-3 - 55 1, 10 - 15 1, 10	· · ·				000	1000	

<sup>(1)</sup> All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. Maximum V<sub>S</sub> for testing purposes is 30 V for LM358 and LM358A.

All typical values are T<sub>A</sub> = 25°C.



## 7.8 Electrical Characteristics: LM2904, LM2904V

For  $V_S = (V+) - (V-) = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ , (unless otherwise noted)

	PARAMETER		TES	T COND	TIONS <sup>(1)</sup>		MIN	<b>TYP</b> (2)	MAX	UNIT
OFFSET	VOLTAGE									
					Non-A suffix			3	7	
		V- = 5 V to maxis	mum: V 0 V: V	1 /	devices	T <sub>A</sub> = -40°C to 125°C			10	
Vos	Input offset voltage	V	mum; $V_{CM} = 0 \text{ V}$ ; $V_{CM} = 0 \text{ V}$	0 - 1.4	A-suffix			1	2	mV
					devices	T <sub>A</sub> = -40°C to 125°C			4	
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift					T <sub>A</sub> = -40°C to 125°C		7		μV/°C
	Input offset voltage vs power	V 5.V4-00.V					05	400		
PSRR	supply $(\Delta V_{IO}/\Delta V_S)$	V <sub>S</sub> = 5 V to 30 V					65	100		dB
$V_{O1}/V_{O2}$	Channel separation	f = 1 kHz to 20 kl	Hz					120		dB
INPUT V	OLTAGE RANGE									<b>-</b>
$V_{CM}$	Common-mode voltage range	V <sub>S</sub> = 5 V to maxii	mum				(V-)		(V+) - 1.5	V
VСМ	Common mode voltage range	VS = 0 V to maxii	Tidiii			$T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$	(V-)		(V+) - 2	•
CMRR	Common-mode rejection ratio	V <sub>S</sub> = 5 V to maxii	mum; V <sub>CM</sub> = 0 V				65	80		dB
INPUT BI	AS CURRENT									
I <sub>B</sub>	Input bias current	V <sub>O</sub> = 1.4 V						-20	-250	nA
'B	input bias current	V <sub>O</sub> = 1.4 V				$T_A = -40$ °C to 125°C			-500	IIA
					Non-V suffix			2	50	
	Input offset current	V = 1.4.V			device	T <sub>A</sub> = -40°C to 125°C			300	n ^
los	input onset current	V <sub>O</sub> = 1.4 V			V-suffix			2	50	nA
					device	$T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$			150	
dl <sub>OS</sub> /d <sub>T</sub>	Input offset current drift				•	T <sub>A</sub> = -40°C to 125°C		10		pA/°C
NOISE										
e <sub>n</sub>	Input voltage noise density	f = 1 kHz						40		nV/√Hz
OPEN-LC	OOP GAIN									
	0 1 1 1	V 45.V.V					25	100		.,, .,
A <sub>OL</sub>	Open-loop voltage gain	$V_S = 15 \text{ V}; V_O = 7$	1 V to 11 V; R <sub>L</sub> ≥ 2	KΩ		T <sub>A</sub> = -40°C to 125°C	15			V/mV
FREQUE	NCY RESPONSE									
GBW	Gain bandwidth product							0.7		MHz
SR	Slew rate	G = +1						0.3		V/µs
OUTPUT										Į.
			R <sub>L</sub> ≥ 10 kΩ				V <sub>S</sub> – 1.5			
				V <sub>S</sub> = ma	aximum; R <sub>L</sub> =				4	
			Non-V suffix	2 kΩ						
		Positive rail	device	V <sub>S</sub> = ma 10 kΩ	aximum; R <sub>L</sub> ≥			2	3	V
$V_{O}$	Voltage output swing from rail	1 doktive rain		-	aximum; R <sub>L</sub> =	$T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$				ľ
			\/#*:	2 kΩ	axiinum, rt_ =				6	
			V-suffix device	V <sub>S</sub> = ma	aximum; R <sub>L</sub> ≥			4	5	
				10 kΩ						
		Negative rail		V <sub>S</sub> = 5	V; R <sub>L</sub> ≤ 10 kΩ	$T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C}$		5	20	mV
		V <sub>S</sub> = 15 V; V <sub>O</sub> = 0	0 V; V <sub>ID</sub> = 1 V	Source			-20	-30		
			, is			$T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}$	-10			mA
Io	Output current	V <sub>S</sub> = 15 V; V <sub>O</sub> = 1	Sink			10	20			
Ü		3 - 7 0	$T_A = -40$ °C to 125°C			5				
		V <sub>ID</sub> = -1 V; V <sub>O</sub> = 2	Non-V	suffix device			30		μA	
				V-suffix	device		12	40		
I <sub>SC</sub>	Short-circuit current	$V_S = 10 \text{ V}; V_O = V_O$	V <sub>S</sub> / 2					±40	±60	mA
POWER S	SUPPLY					T	T			I
lα	Quiescent current per amplifier	$V_O = 2.5 \text{ V}; I_O = 0$	) A	T <sub>A</sub> = -40°C to 125°				350	600	μA
1( )	anoscent current per ampinter	V = maximum: V	$I_0 = \text{maximum} / 2;$	I Λ Δ		1A = -70 0 10 123 0		500	1000	μΛ

<sup>(1)</sup> All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. Maximum V<sub>S</sub> for testing purposes is 26 V for LM2904 and 32 V for LM2904V.

<sup>(2)</sup> All typical values are  $T_A = 25$ °C.



## 7.9 Electrical Characteristics: LM158, LM158A

For  $V_S = (V+) - (V-) = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ , (unless otherwise noted)

	PARAMETER	TE	ST COND	ITIONS <sup>(1)</sup>		MIN	TYP <sup>(2)</sup>	MAX	UNIT
OFFSET	VOLTAGE								
011021	VOLINGE						3	5	
				LM158	T 5500 to 40500		3	5	
Vos	Input offset voltage	V <sub>S</sub> = 5 V to 30 V; V <sub>CM</sub> = 0 V; V <sub>C</sub>	= 1.4 V		$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			7	mV
				LM158A				2	
					$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			4	
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift			LM158	$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$		7		μV/°C
4.09.41	put chock reliage a.m.			LM158A	$T_A = -55$ °C to 125°C		7	15 <sup>(3)</sup>	μ., σ
PSRR	Input offset voltage vs power supply	V <sub>S</sub> = 5 V to 30 V				65	100		dB
	(ΔV <sub>IO</sub> /ΔV <sub>S</sub> )								
V <sub>O1</sub> / V <sub>O2</sub>		f = 1 kHz to 20 kHz					120		dB
INPUT V	OLTAGE RANGE								
		V <sub>S</sub> = 5 V to 30 V		LM158		(V-)		(V+) - 1.5	
V <sub>CM</sub>	Common-mode voltage range	V <sub>S</sub> = 30 V		LM158A		. ,		(	V
· CIVI	Common mode voltage range	V <sub>S</sub> = 5 V to 30 V		LM158	T <sub>A</sub> = -55°C to 125°C	(V-)		(V+) - 2	•
		V <sub>S</sub> = 30 V		LM158A	14 = -33 0 10 123 0	(v-)		(V+) - Z	
CMRR	Common-mode rejection ratio	$V_S = 5 \text{ V to } 30 \text{ V}; V_{CM} = 0 \text{ V}$				70	80		dB
INPUT B	IAS CURRENT	!			*				
							-20	-150	
				LM158	T <sub>A</sub> = -55°C to 125°C			-300	
l <sub>B</sub>	Input bias current	V <sub>O</sub> = 1.4 V			^		-15	-50	nA
				LM158A	T <sub>A</sub> = -55°C to 125°C			-100	
					14 - 00 0 10 120 0		2	30	
				LM158	T FE9C to 40F9C				
los	Input offset current	V <sub>O</sub> = 1.4 V			$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			100	nA
				LM158A			2	10	
					$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			30	
dl <sub>os</sub> /d <sub>T</sub>	Input offset current drift						10		pA/°C
				LM158A	$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			200	
NOISE									
e <sub>n</sub>	Input voltage noise density	f = 1 kHz					40		nV/√Hz
OPEN-L	OOP GAIN								
	0	V 45 V: V 4 V (= 44 V (=	> 0.1:0			50	100		\//\/
A <sub>OL</sub>	Open-loop voltage gain	$V_S = 15 \text{ V}; V_O = 1 \text{ V to } 11 \text{ V}; R_L$	_≥2 kΩ		T <sub>A</sub> = -55°C to 125°C	25			V/mV
FREQUE	NCY RESPONSE	1							
GBW	Gain bandwidth product						0.7		MHz
SR	Slew rate	G = +1					0.3		V/µs
OUTPUT									.,
			V 30 V	/; R <sub>I</sub> = 2 kΩ	$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$			4	
		Positive rail	_	$f$ , $R_L = 2 R \Omega \Omega$ $f$ , $R_L \ge 10 R \Omega$	1 <sub>A</sub> = -33 0 to 123 0		2	3	V
Vo	Voltage output swing from rail	Positive fall							V
				R <sub>L</sub> ≥ 2 kΩ				1.5	
		Negative rail	$V_S = 5 V;$	R <sub>L</sub> ≤ 10 kΩ	$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$		5	20	mV
						-20	-30		
		$V_S = 15 \text{ V}; V_O = 0 \text{ V}; V_{ID} = 1 \text{ V}$	Source	LM158A				-60	
lo	Output current				$T_A = -55^{\circ}C \text{ to } 125^{\circ}C$	-10			mA
J	4	V <sub>S</sub> = 15 V; V <sub>O</sub> = 15 V; V <sub>ID</sub> = -1 Sink				10	20		
		V	O.I.K		$T_A = -55$ °C to 125°C	5			
		$V_{ID} = -1 \text{ V}; V_{O} = 200 \text{ mV}$				12	30		μΑ
I <sub>sc</sub>	Short-circuit current	V <sub>S</sub> = 10 V; V <sub>O</sub> = V <sub>S</sub> / 2					±40	±60	mA
POWER	SUPPLY	+			+			-	
		V <sub>O</sub> = 2.5 V; I <sub>O</sub> = 0 A					350	600	
I <sub>Q</sub>	Quiescent current per amplifier	V <sub>S</sub> = 30 V; V <sub>O</sub> = 15 V; I <sub>O</sub> = 0 A			$T_A = -55^{\circ}\text{C to } 125^{\circ}\text{C}$		500	1000	μΑ
		1.5 - 55 ., .0 - 15 v, 10 - 0 A					000	1000	

<sup>(1)</sup> All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. Maximum V<sub>S</sub> for testing purposes is 30 V for LM158 and LM158A.

<sup>(2)</sup> All typical values are T<sub>A</sub> = 25°C.

<sup>(3)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



## 7.10 Electrical Characteristics: LM258, LM258A

For  $V_0 = (V+) - (V-) = 5 \text{ V}$ ,  $T_A = 25 ^{\circ}\text{C}$ . (unless otherwise noted)

	$= (V+) - (V-) = 5 V, T_A =$		ST COND			MIN	TYP <sup>(2)</sup>	MAX	UNIT
OFFSET	VOLTAGE								
011021	VOLINGE						3	5	
				LM258	T 0500 to 0500		<u> </u>		
Vos	Input offset voltage	$V_S = 5 \text{ V to } 30 \text{ V; } V_{CM} = 0 \text{ V; } V_{C}$	= 1.4 V		$T_A = -25$ °C to 85°C			7	mV
				LM258A			2	3	
					$T_A = -25$ °C to 85°C			4	
dV <sub>OS</sub> /d <sub>T</sub>	Input offset voltage drift			LM258	T <sub>A</sub> = -25°C to 85°C		7		μV/°C
4 1 0 5 4 1	input chock voltage dink			LM258A	1 <sub>A</sub> = 20 0 to 00 0		7	15	μν, σ
PSRR	Input offset voltage vs power supply	V <sub>S</sub> = 5 V to 30 V				65	100		dB
., ,,,	(ΔV <sub>IO</sub> /ΔV <sub>S</sub> )						400		
	Channel separation	f = 1 kHz to 20 kHz					120		dB
INPUT V	OLTAGE RANGE								
		V <sub>S</sub> = 5 V to 30 V		LM258		(V-)		(V+) - 1.5	
$V_{CM}$	Common-mode voltage range	V <sub>S</sub> = 30 V		LM258A		, ,		( , -	V
CIVI	Common mode venage range	V <sub>S</sub> = 5 V to 30 V		LM258	T <sub>A</sub> = -25°C to 85°C	(V-)		(V+) - 2	•
		V <sub>S</sub> = 30 V		LM258A	1 <sub>A</sub> = -23 0 to 63 0	( • – )		( • + ) - 2	
CMRR	Common-mode rejection ratio	$V_S = 5 \text{ V to } 30 \text{ V}; V_{CM} = 0 \text{ V}$				70	80		dB
INPUT B	IAS CURRENT	·!			*			•	
							-20	-150	
				LM258	T <sub>A</sub> = -25°C to 85°C			-300	
I <sub>B</sub>	Input bias current	V <sub>O</sub> = 1.4 V			A		-15	-80	nA
				LM258A	T <sub>A</sub> = -25°C to 85°C			-100	
					1A = 20 0 to 00 0		2	30	
				LM258	T 0500 to 0500				
los	Input offset current	V <sub>O</sub> = 1.4 V			$T_A = -25^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$			100	nA
				LM258A			2	15	
					$T_A = -25^{\circ}\text{C to } 85^{\circ}\text{C}$			30	
dl <sub>os</sub> /d <sub>T</sub>	Input offset current drift						10		pA/°C
00 1	<u> </u>			LM258A	$T_A = -25$ °C to 85°C			200	
NOISE					<u></u>				
$e_n$	Input voltage noise density	f = 1 kHz					40		nV/√Hz
OPEN-L	OOP GAIN								
		V 45VV 4VV 4VV 5				50	100		
A <sub>OL</sub>	Open-loop voltage gain	$V_S = 15 \text{ V}; V_O = 1 \text{ V to } 11 \text{ V}; R_L$	_≥2 kΩ		$T_A = -25$ °C to 85°C	25			V/mV
FREQUE	NCY RESPONSE	1			<u> </u>				
GBW	Gain bandwidth product						0.7		MHz
SR	Slew rate	G = +1					0.3		V/µs
OUTPUT		0 - 11					0.0		17,40
0011 01			V - 20 V	/; R <sub>L</sub> = 2 kΩ	T <sub>A</sub> = -25°C to 85°C			4	
		Desitive vail			1 <sub>A</sub> = -23 C to 63 C		2	3	V
Vo	Voltage output swing from rail	Positive rail		/; R <sub>L</sub> ≥ 10 kΩ					V
				$R_L \ge 2 k\Omega$				1.5	
		Negative rail	$V_S = 5 V;$	R <sub>L</sub> ≤ 10 kΩ	$T_A = -25$ °C to 85°C		5	20	mV
						-20	-30		
		$V_S = 15 \text{ V}; V_O = 0 \text{ V}; V_{ID} = 1 \text{ V}$	Source	LM258A				-60	
I.	Output current				$T_A = -25^{\circ}C$ to $85^{\circ}C$	-10			mA
l <sub>o</sub>	- apar ourion	$V_S = 15 \text{ V}; V_O = 15 \text{ V}; V_{ID} = -1$ Sink				10	20		
		V	Ollik		$T_A = -25$ °C to 85°C	5	<u> </u>		
		$V_{ID} = -1 \text{ V}; V_{O} = 200 \text{ mV}$				12	30		μΑ
I <sub>sc</sub>	Short-circuit current	V <sub>S</sub> = 10 V; V <sub>O</sub> = V <sub>S</sub> / 2					±40	±60	mA
	SUPPLY	-							
		V <sub>O</sub> = 2.5 V; I <sub>O</sub> = 0 A					350	600	
lα	Quiescent current per amplifier	$V_S = 30 \text{ V}; V_O = 15 \text{ V}; I_O = 0 \text{ A}$			$T_A = -25^{\circ}\text{C to } 85^{\circ}\text{C}$		500	1000	μΑ
		v <sub>5</sub> - 30 v, v <sub>0</sub> - 13 v, 1 <sub>0</sub> = 0 A					300	1000	

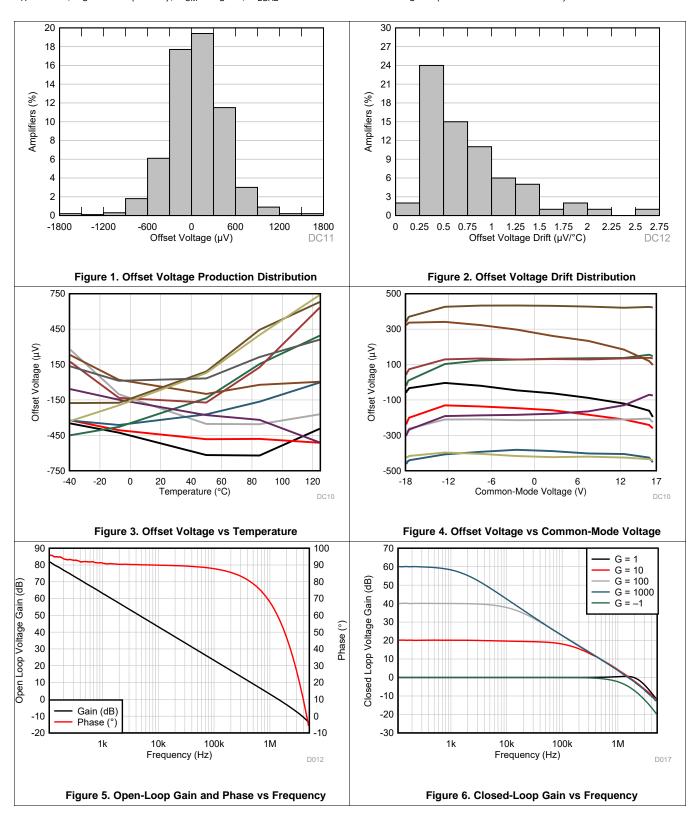
<sup>(1)</sup> All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified. Maximum V<sub>S</sub> for testing purposes is 30 V for LM258 and LM258A.

All typical values are T<sub>A</sub> = 25°C.



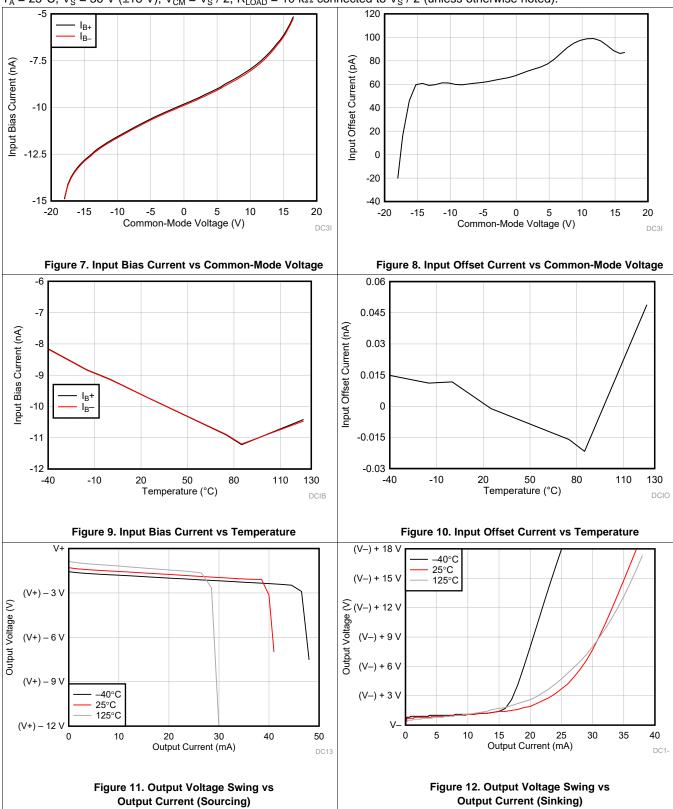
## 7.11 Typical Characteristics

Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}C$ ,  $V_S = 36$  V (±18 V),  $V_{CM} = V_S$  / 2,  $R_{LOAD} = 10$  k $\Omega$  connected to  $V_S$  / 2 (unless otherwise noted).



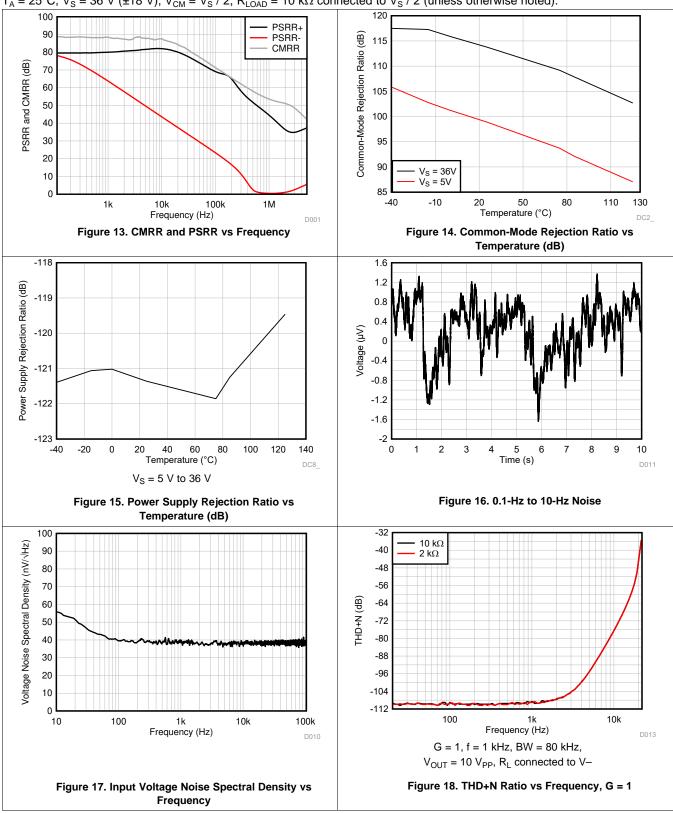


Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}\text{C}$ ,  $V_S = 36 \text{ V}$  (±18 V),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10 \text{ k}\Omega$  connected to  $V_S / 2$  (unless otherwise noted).



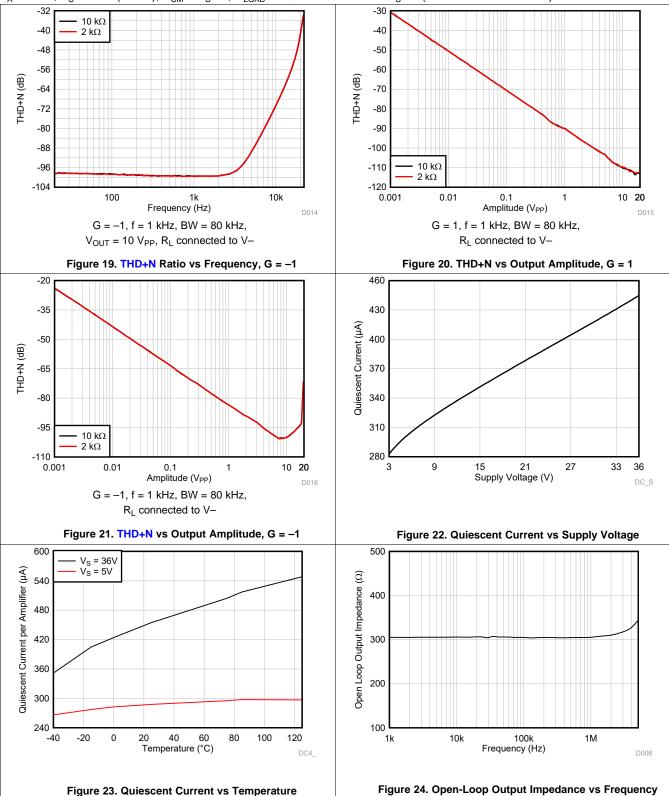


Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}\text{C}$ ,  $V_S = 36 \text{ V}$  (±18 V),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10 \text{ k}\Omega$  connected to  $V_S / 2$  (unless otherwise noted).



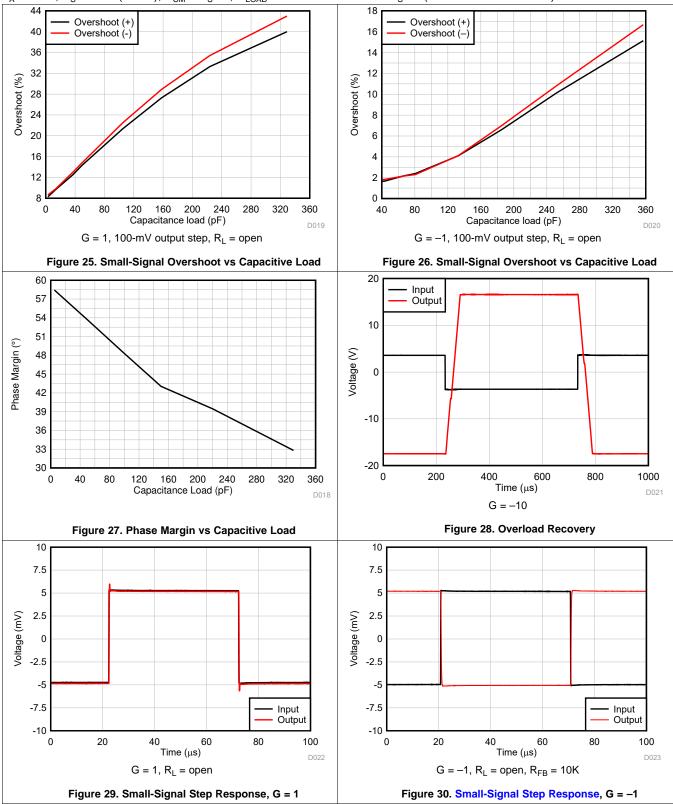


Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}\text{C}$ ,  $V_S = 36 \text{ V}$  (±18 V),  $V_{CM} = V_S / 2$ ,  $R_{LOAD} = 10 \text{ k}\Omega$  connected to  $V_S / 2$  (unless otherwise noted).



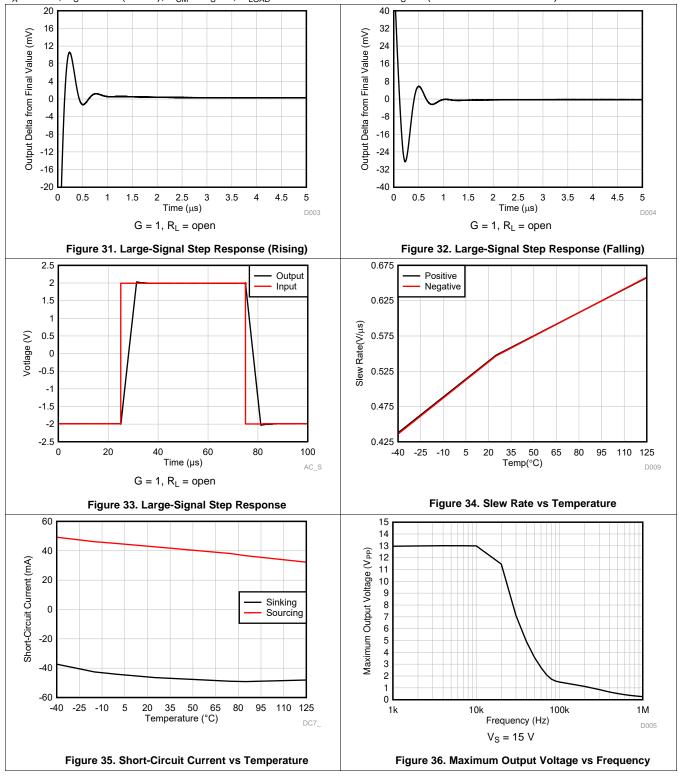


Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}C$ ,  $V_S = 36$  V (±18 V),  $V_{CM} = V_S$  / 2,  $R_{LOAD} = 10$  k $\Omega$  connected to  $V_S$  / 2 (unless otherwise noted).



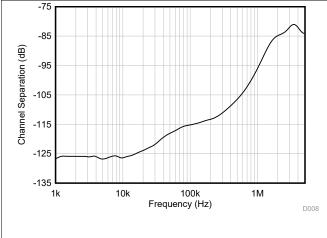


Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A$  = 25°C,  $V_S$  = 36 V (±18 V),  $V_{CM}$  =  $V_S$  / 2,  $R_{LOAD}$  = 10 k $\Omega$  connected to  $V_S$  / 2 (unless otherwise noted).





Typical characteristics section is applicable for LM358B and LM2904B. The typical characteristics data section was taken with  $T_A = 25^{\circ}C$ ,  $V_S = 36$  V (±18 V),  $V_{CM} = V_S$  / 2,  $R_{LOAD} = 10$  k $\Omega$  connected to  $V_S$  / 2 (unless otherwise noted).





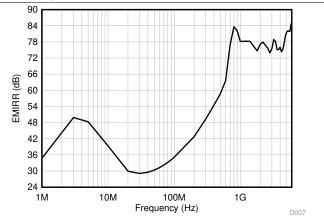
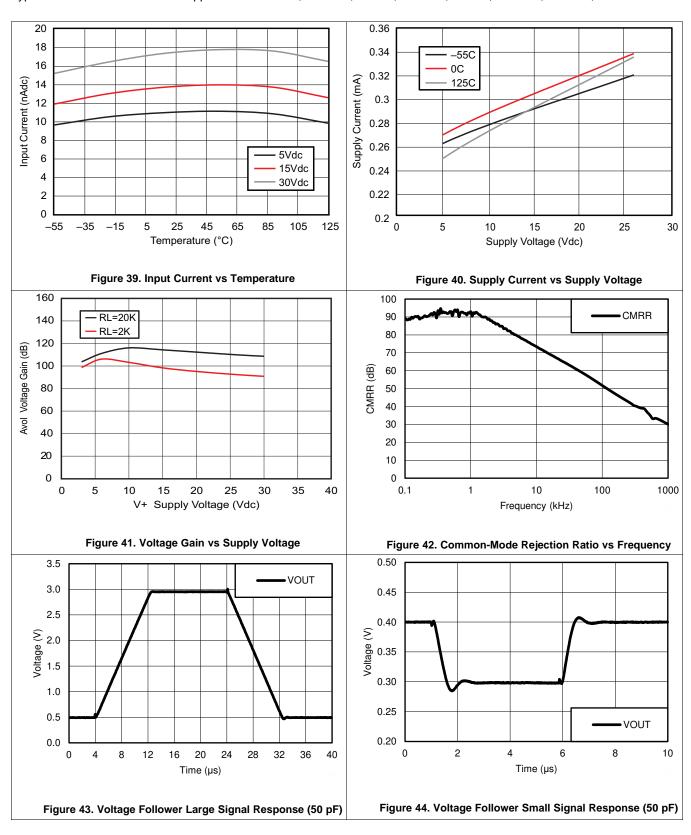


Figure 38. EMIRR (Electromagnetic Interference Rejection Ratio) vs Frequency



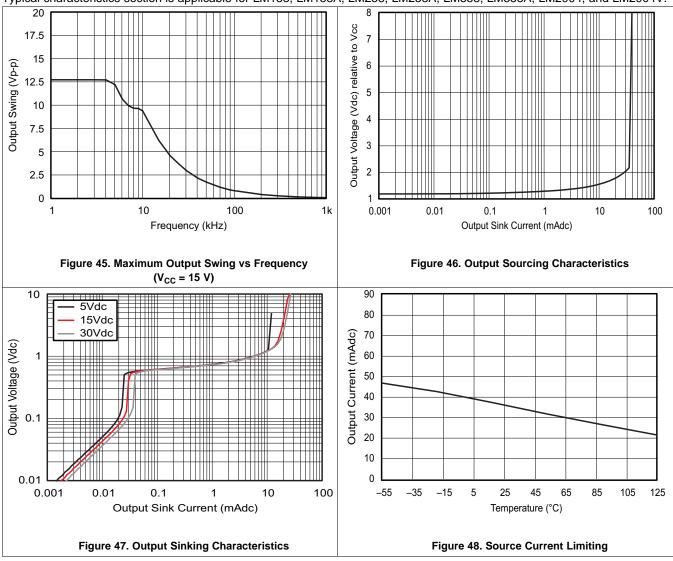
## 7.12 Typical Characteristics

Typical characteristics section is applicable for LM158, LM158A, LM258, LM258A, LM358A, LM358A, LM2904, and LM2904V.





Typical characteristics section is applicable for LM158, LM158A, LM258, LM258A, LM358A, LM2904, and LM2904V.





## 8 Parameter Measurement Information

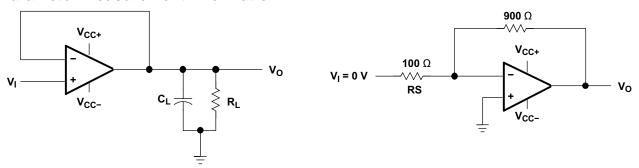


Figure 49. Unity-Gain Amplifier

Figure 50. Noise-Test Circuit

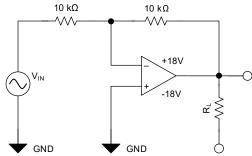


Figure 51. Test Circuit, G = −1, for THD+N and Small-Signal Step Response



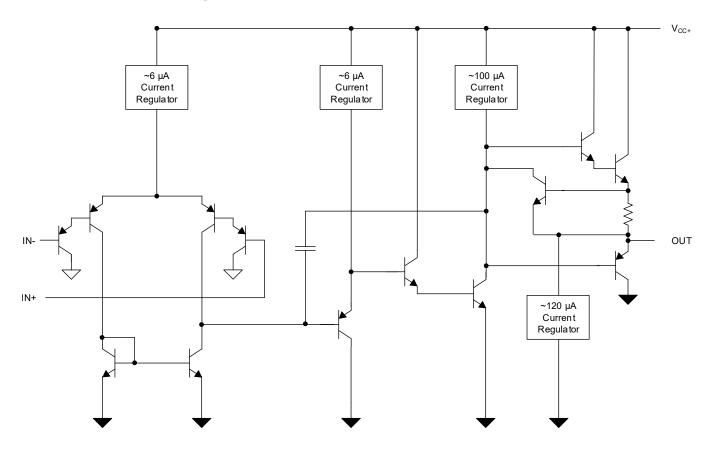
## 9 Detailed Description

#### 9.1 Overview

These devices consist of two independent, high-gain frequency-compensated operational amplifiers designed to operate from a single supply over a wide range of voltages. Operation from split supplies also is possible if the difference between the two supplies is within the supply voltage range specified in the *Recommended Operating Conditions* section, and V<sub>S</sub> is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, dc amplification blocks, and all the conventional operational amplifier circuits that now can be implemented more easily in single-supply-voltage systems. For example, these devices can be operated directly from the standard 5-V supply used in digital systems and easily can provide the required interface electronics without additional ±5-V supplies.

#### 9.2 Functional Block Diagram - LM358B, LM358BA, LM2904B, LM2904BA





#### 9.3 Feature Description

#### 9.3.1 Unity-Gain Bandwidth

The unity-gain bandwidth is the frequency up to which an amplifier with a unity gain may be operated without greatly distorting the signal. These devices have a 1.2-MHz unity-gain bandwidth (B Version).

#### 9.3.2 Slew Rate

The slew rate is the rate at which an operational amplifier can change its output when there is a change on the input. These devices have a 0.5-V/µs slew rate (B Version).

## 9.3.3 Input Common Mode Range

The valid common mode range is from device ground to  $V_S - 1.5 \text{ V}$  ( $V_S - 2 \text{ V}$  across temperature). Inputs may exceed  $V_S$  up to the maximum  $V_S$  without device damage. At least one input must be in the valid input common-mode range for the output to be the correct phase. If both inputs exceed the valid range, then the output phase is undefined. If either input more than 0.3 V below V- then input current should be limited to 1 mA and the output phase is undefined.

#### 9.4 Device Functional Modes

These devices are powered on when the supply is connected. This device can be operated as a single-supply operational amplifier or dual-supply amplifier, depending on the application.



## 10 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### **10.1** Application Information

The LMx58 and LM2904 operational amplifiers are useful in a wide range of signal conditioning applications. Inputs can be powered before  $V_S$  for flexibility in multiple supply circuits.

## 10.2 Typical Application

A typical application for an operational amplifier is an inverting amplifier. This amplifier takes a positive voltage on the input, and makes it a negative voltage of the same magnitude. In the same manner, it also makes negative voltages positive.

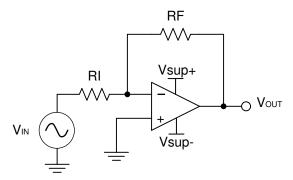


Figure 52. Application Schematic

#### 10.2.1 Design Requirements

The supply voltage must be chosen such that it is larger than the input voltage range and output range. For instance, this application scales a signal of  $\pm 0.5$  V to  $\pm 1.8$  V. Setting the supply at  $\pm 12$  V is sufficient to accommodate this application.

#### 10.2.2 Detailed Design Procedure

Determine the gain required by the inverting amplifier using Equation 1 and Equation 2:

$$A_{V} = \frac{VOUT}{VIN}$$

$$A_{V} = \frac{1.8}{-0.5} = -3.6$$
(2)

Once the desired gain is determined, choose a value for  $R_I$  or  $R_F$ . [Subscripts should be fixed in the accompanying figures and equations also.] Choosing a value in the kilohm range is desirable because the amplifier circuit uses currents in the milliampere range. This ensures the part does not draw too much current. This example uses 10 k $\Omega$  for  $R_I$  which means 36 k $\Omega$  is used for  $R_F$ . This was determined by Equation 3.

$$A_{V} = -\frac{RF}{RI}$$
 (3)



## **Typical Application (continued)**

## 10.2.3 Application Curve

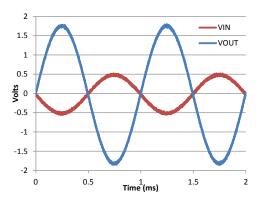


Figure 53. Input and Output Voltages of the Inverting Amplifier

## 11 Power Supply Recommendations

#### **CAUTION**

Supply voltages larger than specified in the recommended operating region can permanently damage the device (see the *Absolute Maximum Ratings*).

Place 0.1-µF bypass capacitors close to the power-supply pins to reduce errors coupling in from noisy or high-impedance power supplies. For more detailed information on bypass capacitor placement, see the *Layout* section.

## 12 Layout

#### 12.1 Layout Guidelines

For best operational performance of the device, use good PCB layout practices, including:

- Noise can propagate into analog circuitry through the power pins of the circuit as a whole, as well as the
  operational amplifier. Bypass capacitors are used to reduce the coupled noise by providing low-impedance
  power sources local to the analog circuitry.
  - Connect low-ESR, 0.1-µF ceramic bypass capacitors between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from V+ to ground is applicable for singlesupply applications.
- Separate grounding for analog and digital portions of circuitry is one of the simplest and most-effective
  methods of noise suppression. One or more layers on multilayer PCBs are usually devoted to ground planes.
  A ground plane helps distribute heat and reduces EMI noise pickup. Make sure to physically separate digital
  and analog grounds, paying attention to the flow of the ground current.
- To reduce parasitic coupling, run the input traces as far away from the supply or output traces as possible. If
  it is not possible to keep them separate, it is much better to cross the sensitive trace perpendicular as
  opposed to in parallel with the noisy trace. [Things in parallel never cross, by definition]
- Place the external components as close to the device as possible. Keeping R<sub>F</sub> and R<sub>G</sub> close to the inverting
  input minimizes parasitic capacitance, as shown in *Layout Examples*.
- Keep the length of input traces as short as possible. Always remember that the input traces are the most sensitive part of the circuit.
- Consider a driven, low-impedance guard ring around the critical traces. A guard ring can significantly reduce leakage currents from nearby traces that are at different potentials.

## 12.2 Layout Examples

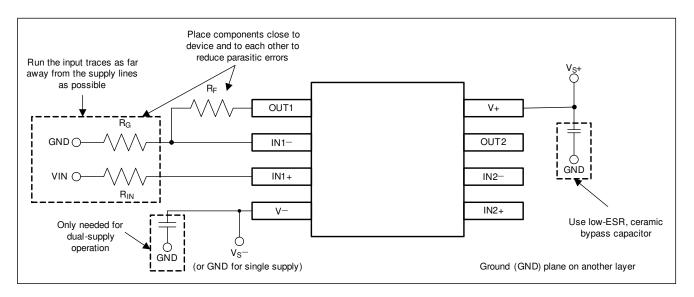


Figure 54. Operational Amplifier Board Layout for Noninverting Configuration

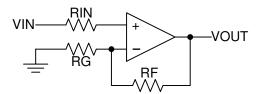


Figure 55. Operational Amplifier Schematic for Noninverting Configuration



## 13 Device and Documentation Support

#### 13.1 Documentation Support

#### 13.1.1 Related Documentation

· Texas Instruments, Circuit Board Layout Techniques.

#### 13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

**Table 1. Related Links** 

PARTS	PRODUCT FOLDER	ORDER NOW	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
LM158	Click here	Click here	Click here	Click here	Click here
LM158A	Click here	Click here	Click here	Click here	Click here
LM258	Click here	Click here	Click here	Click here	Click here
LM258A	Click here	Click here	Click here	Click here	Click here
LM358	Click here	Click here	Click here	Click here	Click here
LM358A	Click here	Click here	Click here	Click here	Click here
LM358B	Click here	Click here	Click here	Click here	Click here
LM2904	Click here	Click here	Click here	Click here	Click here
LM2904B	Click here	Click here	Click here	Click here	Click here
LM2904V	Click here	Click here	Click here	Click here	Click here

## 13.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 13.4 Community Resources

TI E2E<sup>TM</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 13.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

#### 13.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 13.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms and definitions.



## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most-current data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser based versions of this data sheet, see the left-hand navigation pane.





6-Feb-2020

## **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-87710012A	ACTIVE	LCCC	FK	20	1	(2) TBD	(6) POST-PLATE	(3) N / A for Pkg Type	-55 to 125	5962- 87710012A LM158FKB	Samples
5962-8771001PA	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8771001PA LM158	Samples
5962-87710022A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 87710022A LM158AFKB	Samples
5962-8771002PA	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8771002PA LM158A	Samples
LM158 MW8	ACTIVE	WAFERSALE	YS	0	1	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-55 to 125		Samples
LM158AFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 87710022A LM158AFKB	Samples
LM158AJG	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	LM158AJG	Samples
LM158AJGB	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8771002PA LM158A	Samples
LM158FKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 87710012A LM158FKB	Samples
LM158JG	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	LM158JG	Samples
LM158JGB	ACTIVE	CDIP	JG	8	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	8771001PA LM158	Samples
LM258AD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258A	Samples
LM258ADGKR	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-25 to 85	(M3L, M3P, M3S, M3 U)	Samples
LM258ADR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	-25 to 85	LM258A	Samples
LM258ADRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258A	Samples
LM258ADRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258A	Samples





Orderable Device	Status	Package Type	_	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	<b>Device Marking</b>	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM258AP	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU   SN	N / A for Pkg Type	-25 to 85	LM258AP	Samples
LM258APE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	-25 to 85	LM258AP	Samples
LM258D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258	Samples
LM258DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258	Samples
LM258DGKR	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-25 to 85	(M2L, M2P, M2S, M2 U)	Samples
LM258DGKRG4	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAUAG	Level-1-260C-UNLIM	-25 to 85	(M2L, M2P, M2S, M2 U)	Samples
LM258DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	-25 to 85	LM258	Samples
LM258DRG3	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	-25 to 85	LM258	Samples
LM258DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	LM258	Samples
LM258P	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU   SN	N / A for Pkg Type	-25 to 85	LM258P	Samples
LM258PE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	-25 to 85	LM258P	Samples
LM2904AVQDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904AV	Samples
LM2904AVQDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904AV	Samples
LM2904AVQPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904AV	Samples
LM2904AVQPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904AV	Samples
LM2904BAIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	2904BA	Samples
LM2904BIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	L2904B	Samples
LM2904BIPWR	PREVIEW	TSSOP	PW	8	2000	TBD	Call TI	Call TI	-40 to 125		





Orderable Device	Status	Package Type		Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM2904D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2904	Samples
LM2904DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904DGKR	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	(MBL, MBP, MBS, MB U)	Sample
LM2904DGKRG4	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	(MBL, MBP, MBS, MB U)	Sample
LM2904DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904DRG3	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2904	Sample
LM2904P	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU   SN	N / A for Pkg Type	-40 to 125	LM2904P	Sample
LM2904PE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	-40 to 125	LM2904P	Sample
LM2904PSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904	Sample
LM2904PW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904	Sample
LM2904PWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 125	L2904	Sample
LM2904PWRG3	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	-40 to 125	L2904	Sample
LM2904PWRG4-JF	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904	Sample
LM2904QDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2904Q1	Sample
LM2904QDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2904Q1	Sample





Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
LM2904VQDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904V	Sample
LM2904VQDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904V	Sample
LM2904VQPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904V	Sample
LM2904VQPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 125	L2904V	Sample
LM358AD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358ADE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358ADG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358ADGKR	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	0 to 70	(M6L, M6P, M6S, M6 U)	Sample
LM358ADGKRG4	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAUAG	Level-1-260C-UNLIM	0 to 70	(M6L, M6P, M6S, M6 U)	Sample
LM358ADR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358ADRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358ADRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358A	Sample
LM358AP	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU   SN	N / A for Pkg Type	0 to 70	LM358AP	Sample
LM358APE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	LM358AP	Samples
LM358APW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358A	Samples
LM358APWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	L358A	Samples
LM358APWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358A	Samples
LM358BAIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	L358BA	Sample





Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM358BIDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	LM358B	Samples
LM358BIPWR	PREVIEW	TSSOP	PW	8	2000	TBD	Call TI	Call TI	-40 to 85		
LM358D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358DGKR	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   NIPDAUAG	Level-1-260C-UNLIM	0 to 70	(M5L, M5P, M5S, M5 U)	Samples
LM358DGKRG4	ACTIVE	VSSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	NIPDAUAG	Level-1-260C-UNLIM	0 to 70	(M5L, M5P, M5S, M5 U)	Samples
LM358DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358DRG3	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM358	Samples
LM358P	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU   SN	N / A for Pkg Type	0 to 70	LM358P	Samples
LM358PE3	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	SN	N / A for Pkg Type	0 to 70	LM358P	Samples
LM358PE4	ACTIVE	PDIP	Р	8	50	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	LM358P	Samples
LM358PSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358	Samples
LM358PW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358	Samples
LM358PWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU   SN	Level-1-260C-UNLIM	0 to 70	L358	Samples
LM358PWRG3	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	SN	Level-1-260C-UNLIM	0 to 70	L358	Samples
LM358PWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358	Samples



## **PACKAGE OPTION ADDENDUM**

6-Feb-2020

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM358PWRG4-JF	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	L358	Samples
PLM2904BIPWR	ACTIVE	TSSOP	PW	8	2000	TBD	Call TI	Call TI	-40 to 125		Samples
PLM358BIPWR	ACTIVE	TSSOP	PW	8	2000	TBD	Call TI	Call TI	-40 to 85		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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### **PACKAGE OPTION ADDENDUM**

6-Feb-2020

#### OTHER QUALIFIED VERSIONS OF LM258A, LM2904, LM2904B:

Automotive: LM2904-Q1, LM2904B-Q1

• Enhanced Product: LM258A-EP, LM2904-EP

#### NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications

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### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM258ADGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM258ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258ADR	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258ADR	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM258ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258ADRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258ADRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM258DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DR	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DR	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM258DRG3	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM258DRG3	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM258DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904AVQDR	SOIC	D	8	2500	330.0	12.5	6.4	5.2	2.1	8.0	12.0	Q1
LM2904AVQDRG4	SOIC	D	8	2500	330.0	12.5	6.4	5.2	2.1	8.0	12.0	Q1

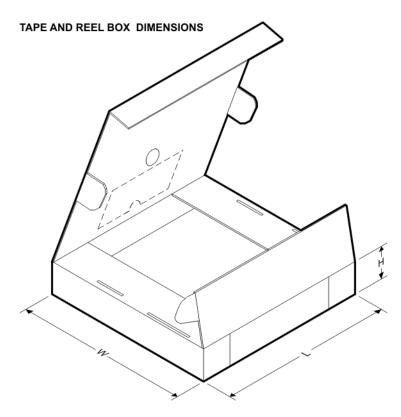


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Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2904AVQPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904AVQPWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904BAIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904BIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2904DGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2904DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DR	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DR	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DRG3	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DRG3	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904PWRG3	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904PWRG4-JF	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904QDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM2904VQDR	SOIC	D	8	2500	330.0	12.5	6.4	5.2	2.1	8.0	12.0	Q1
LM2904VQPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM2904VQPWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358ADGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM358ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358ADR	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358ADR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358ADR	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM358ADRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358ADRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358APWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358APWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358APWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358BAIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358BIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358DGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM358DGKR	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM358DR	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM358DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358DR	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358DRG3	SOIC	D	8	2500	330.0	15.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358DRG3	SOIC	D	8	2500	330.0	12.8	6.4	5.2	2.1	8.0	12.0	Q1
LM358DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM358DRG4	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
LM358PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358PWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358PWRG3	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358PWRG4	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1
LM358PWRG4-JF	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM258ADGKR	VSSOP	DGK	8	2500	364.0	364.0	27.0
LM258ADR	SOIC	D	8	2500	340.5	338.1	20.6
LM258ADR	SOIC	D	8	2500	333.2	345.9	28.6
LM258ADR	SOIC	D	8	2500	364.0	364.0	27.0
LM258ADR	SOIC	D	8	2500	367.0	367.0	35.0
LM258ADRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM258ADRG4	SOIC	D	8	2500	367.0	367.0	35.0
LM258DGKR	VSSOP	DGK	8	2500	364.0	364.0	27.0
LM258DR	SOIC	D	8	2500	340.5	338.1	20.6
LM258DR	SOIC	D	8	2500	367.0	367.0	35.0
LM258DR	SOIC	D	8	2500	333.2	345.9	28.6



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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM258DR	SOIC	D	8	2500	364.0	364.0	27.0
LM258DRG3	SOIC	D	8	2500	364.0	364.0	27.0
LM258DRG3	SOIC	D	8	2500	333.2	345.9	28.6
LM258DRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM258DRG4	SOIC	D	8	2500	367.0	367.0	35.0
LM2904AVQDR	SOIC	D	8	2500	340.5	338.1	20.6
LM2904AVQDRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM2904AVQPWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LM2904AVQPWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0
LM2904BAIDR	SOIC	D	8	2500	340.5	338.1	20.6
LM2904BIDR	SOIC	D	8	2500	340.5	338.1	20.6
LM2904DGKR	VSSOP	DGK	8	2500	364.0	364.0	27.0
LM2904DGKR	VSSOP	DGK	8	2500	358.0	335.0	35.0
LM2904DR	SOIC	D	8	2500	340.5	338.1	20.6
LM2904DR	SOIC	D	8	2500	333.2	345.9	28.6
LM2904DR	SOIC	D	8	2500	364.0	364.0	27.0
LM2904DR	SOIC	D	8	2500	367.0	367.0	35.0
LM2904DRG3	SOIC	D	8	2500	333.2	345.9	28.6
LM2904DRG3	SOIC	D	8	2500	364.0	364.0	27.0
LM2904DRG4	SOIC	D	8	2500	367.0	367.0	35.0
LM2904DRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM2904PWR	TSSOP	PW	8	2000	364.0	364.0	27.0
LM2904PWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LM2904PWRG3	TSSOP	PW	8	2000	364.0	364.0	27.0
LM2904PWRG4-JF	TSSOP	PW	8	2000	367.0	367.0	35.0
LM2904QDR	SOIC	D	8	2500	350.0	350.0	43.0
LM2904VQDR	SOIC	D	8	2500	340.5	338.1	20.6
LM2904VQPWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LM2904VQPWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0
LM358ADGKR	VSSOP	DGK	8	2500	364.0	364.0	27.0
LM358ADR	SOIC	D	8	2500	367.0	367.0	35.0
LM358ADR	SOIC	D	8	2500	333.2	345.9	28.6
LM358ADR	SOIC	D	8	2500	340.5	338.1	20.6
LM358ADR	SOIC	D	8	2500	364.0	364.0	27.0
LM358ADRG4	SOIC	D	8	2500	367.0	367.0	35.0
LM358ADRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM358APWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LM358APWR	TSSOP	PW	8	2000	364.0	364.0	27.0
LM358APWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0
LM358BAIDR	SOIC	D	8	2500	340.5	338.1	20.6
LM358BIDR	SOIC	D	8	2500	340.5	338.1	20.6
LM358DGKR	VSSOP	DGK	8	2500	358.0	335.0	35.0
LM358DGKR	VSSOP	DGK	8	2500	364.0	364.0	27.0
LM358DR	SOIC	D	8	2500	364.0	364.0	27.0



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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM358DR	SOIC	D	8	2500	367.0	367.0	35.0
LM358DR	SOIC	D	8	2500	333.2	345.9	28.6
LM358DR	SOIC	D	8	2500	340.5	338.1	20.6
LM358DRG3	SOIC	D	8	2500	333.2	345.9	28.6
LM358DRG3	SOIC	D	8	2500	364.0	364.0	27.0
LM358DRG4	SOIC	D	8	2500	340.5	338.1	20.6
LM358DRG4	SOIC	D	8	2500	367.0	367.0	35.0
LM358PWR	TSSOP	PW	8	2000	364.0	364.0	27.0
LM358PWR	TSSOP	PW	8	2000	367.0	367.0	35.0
LM358PWRG3	TSSOP	PW	8	2000	364.0	364.0	27.0
LM358PWRG4	TSSOP	PW	8	2000	367.0	367.0	35.0
LM358PWRG4-JF	TSSOP	PW	8	2000	367.0	367.0	35.0

# FK (S-CQCC-N\*\*)

### LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004





SMALL OUTLINE INTEGRATED CIRCUIT



- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# PS (R-PDSO-G8)

### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



### JG (R-GDIP-T8)

#### **CERAMIC DUAL-IN-LINE**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

# P (R-PDIP-T8)

### PLASTIC DUAL-IN-LINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.



# DGK (S-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.



# DGK (S-PDSO-G8)

### PLASTIC SMALL OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153, variation AA.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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